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DECLARATION

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name,

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled METHOD AND APPARATUS FOR FAST DTMF DETECTION, the specification of which

(Check one) ☒ is attached hereto.

☐ was filed on _____ as
Application Serial No. _____
and was amended on _____
(if applicable)

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, S.1.56.

I hereby claim foreign priority benefits under Title 35, United States Code, S.119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

Prior Foreign Application(s)

			<u>Priority Claimed</u>	
_____ (Number)	_____ (Country)	_____ (Day/Month/Year Filed)	<input type="checkbox"/> Yes	<input type="checkbox"/> No
_____ (Number)	_____ (Country)	_____ (Day/Month/Year Filed)	<input type="checkbox"/> Yes	<input type="checkbox"/> No

I hereby claim the benefit under Title 35, United States Code, S. 119(e) of any United States provisional application(s) listed below.

_____ (Application Number)	_____ (Filing Date)
_____ (Application Number)	_____ (Filing Date)

I hereby claim the benefit under Title 35, United States Code, S.120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, S.112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, S.1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

(Application Serial No.)	(Filing Date)	(Status) (Patented, pending, abandoned)
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(Application Serial No.)	(Filing Date)	(Status) Patented, pending, abandoned)
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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Joachim FOURET

Full name of first inventor

Inventor's Signature

Date Citizenship

Post Office Address:

**895 High Road
London
N12 8QA
United Kingdom**

Residence Address:
same as above

X M. Ashadi
Inventor's Signature

X 01/Jan/2004 X ENGLAND

Post Office Address:
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Mohamed EL-HENNAWEY

Full name of third inventor

Inventor's Signature

	Canadian
Date	Citizenship

Post Office Address:

19 Kensington Crescent
Belleville, Ontario
K8P 4T4, Canada

Residence Address:
same as above

Can LIAO

Full name of fourth inventor

Inventor's Signature

Date Canadian
Citizenship

Post Office Address:

**32 Spruce Gardens
Belleville, Ontario
K8N 5Y6, Canada**

Residence Address:
same as above



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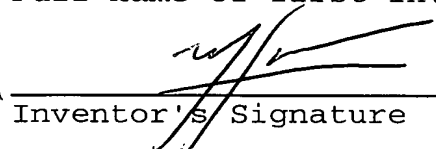
(Application Serial No.)	(Filing Date)	(Status) (Patented, pending, abandoned)
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Joachim FOURET

Full name of first inventor

X 
Inventor's Signature

X 17/12/2003
Date

X FRANCE
Citizenship

Post Office Address:

**895 High Road
London
N12 8QA
United Kingdom**

Residence Address:
same as above

Masoud AHMADI

Full name of second inventor

Inventor's Signature

Date Citizenship

Post Office Address:

Residence Address:
same as above

Mohamed EL-HENNAWEY

Full name of third inventor

Inventor's Signature

Date **Canadian**
Citizenship

Post Office Address:

**19 Kensington Crescent
Belleville, Ontario
K8P 4T4, Canada**

Residence Address:
same as above

Can LIAO

Full name of fourth inventor

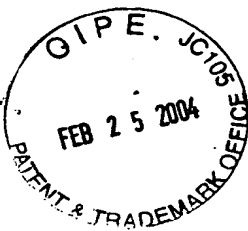
Inventor's Signature

Date Canadian
Citizenship

Post Office Address:

**32 Spruce Gardens
Belleville, Ontario
K8N 5Y6, Canada**

Residence Address:
same as above



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Mohamed EL-HENNAWEY

Full name of sole or first inventor


Inventor's Signature

23 Oct. 2003 Canadian
Date Citizenship

Post Office Address:

19 Kensington Crescent
Belleville, Ontario
K8P 4T4, Canada

Residence Address:
same as above

Can LIAO

Full name of second inventor

Can Liao
Inventor's Signature

Oct. 23, 2003 Canadian
Date Citizenship

Post Office Address:

32 Spruce Gardens
Belleville, Ontario
K8N 5Y6, Canada

Residence Address:
same as above

Joachim FOURET

Full name of third inventor

Inventor's Signature

Date Citizenship

Post Office Address:

Residence Address:
same as above

Masoud AHMADI

Full name of fourth inventor

Inventor's Signature

Date Citizenship

Post Office Address:

Residence Address:
same as above

Residence Address:
same as above